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InGaN/GaN laser diode characterization and quantum well number effect

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InGaN-based semiconductors have recently attracted much attention by the researchers, especially for their light-emitting device applications, such as high-brightness light-emitting diodes (LEDs) and continuous-wave (CW) multi quantum wells (MQWs) blue laser diodes (LDs). However, their optical properties are strongly affected by the quantum-confined Stark effect (QCSE) due to the presence of a large piezoelectric (PZ) field in the quantum well which arises from the strain caused by the lattice mismatch between GaN and InGaN[1,2].

The most important operating parameters in InGaN/GaN LDs are the internal quantum efficiency \( \eta_i \), the internal loss \( \alpha_i \), and the transparency current density \( J_0 \)[3,4]. The characteristic temperature is also a very important parameter from the viewpoint of the practical application of these lasers. The external differential quantum efficiency (DQE) \( \eta_d \) depends on \( \eta_i \) and the photon losses \( \eta_0 \) as[5]

\[
\eta_d = \eta_i \eta_0.
\]  

\( \eta_0 \) can be expressed as

\[
\eta_0 = \alpha_m / (\alpha_i + \alpha_m),
\]  

where \( \alpha_m \) is the optical mirror loss coefficient:

\[
\alpha_m = L^{-1} \ln(1/R),
\]  

which is depending on the laser length \( L \) and the reflectivity of mirror facets of the laser \( R \), leading to the common expression of

\[
\frac{1}{\eta_d} = \frac{1}{\eta_i} \left( \frac{L \alpha_i}{\ln(1/R) + 1} + \frac{1}{\eta_0} \right).
\]  

\( \eta_d^{-1}(L) \) is widely used to determine \( \eta_i \) and \( \alpha_i \) from the length-current (L-I) measurements with different laser lengths. The internal quantum efficiency is independent of the geometrical properties of the laser device, such as the cavity length or the stripe width. In this letter, we extract these parameters for InGaN/GaN LDs with various quantum well numbers. The effect of well number on the temperature characteristics is also investigated through the simulation software.

Experimental and theoretical work done by Domen et al.[6] concluded that the InGaN LD quantum efficiency could be improved when the number of wells is decreased. Our work supports the prior research result and explains the reasons behind it. Advanced laser simulation is used to analyze the internal physical processes of the InGaN/GaN LD. We have also utilized the commercially available laser simulation software[7] to reveal the performance limiting mechanisms and to explore the design optimization options.

The laser simulation program solved the Poisson equation, the current continuity equations, the photon rate equation, and the scalar wave equation by using the two-dimensional (2D) simulator. In addition, the carrier drift-diffusion model which includes Fermi statistics and incomplete ionization was included in our simulation models.

The Shockley Read-Hall (SRH) recombination lifetimes of electrons and holes are assumed to be 1 ns. However, this is a rough estimate since the type and density of recombination centers are sensitive to the technological process. From its bandgap dependence in other materials, a very small Auger parameter of \( C = 1 \times 10^{-34} \) (cm\(^6\)/s) is estimated for GaN. Thus, even with large carrier densities, the Auger recombination in nitride materials is negligible. In our strained InGaN quantum wells, GaN values are used for the deformation potentials.

We started with a simple free carrier gain model including a hyperbolic-cosine broadening function with 0.1-ps scattering time. Optical reflection and waveguide mainly
depend on the refractive index profile inside the device. For photon energies close to the bandgap, the refractive index is a strong function of wavelength. The refractive indices of ternary alloys involved are extracted from GaN waveguide measurements\(^{(8,9)}\) using bandgap variations \((x < 0.3)\) and are given by

\[
n(Al_xGa_{1-x}N) = 2.5067 - 0.43x, \quad (5)
\]

\[
n(In_xGa_{1-x}N) = 2.5067 + 0.91x. \quad (6)
\]

The bandgap energies of the \(In_xGa_{1-x}N\) and \(Al_xGa_{1-x}N\) ternary alloys at room temperature are governed by

\[
E_{gln}\text{In}, Ga_{1-x}N = xE_{gln}InN + (1-x)E_{gln}GaN - 1.43x(1-x), \quad (7)
\]

\[
E_{gln}\text{Al}, Ga_{1-x}N = xE_{gln}AlN + (1-x)E_{gln}GaN - 1.3x(1-x), \quad (8)
\]

\(E_{gln}InN\), \(E_{gln}GaN\), and \(E_{gln}AlN\) are the bandgap energies of InN, GaN, and AlN at room temperature, respectively. The bandgap energies of InN, GaN, and AlN used in our simulation are 0.77, 3.42, and 6.2 eV, respectively\(^{(10,11)}\).

The effective masses of electrons and holes for the active layer \(In_xGa_{1-x}N\) used in our laser simulation were calculated by

\[
m_{e, In_xGa_{1-x}N} = m_{e, GaN} + x(m_{e, InN} - m_{e, GaN}), \quad (9)
\]

\[
m_{hh, In_xGa_{1-x}N} = m_{hh, GaN} + x(m_{hh, InN} - m_{hh, GaN}), \quad (10)
\]

\[
m_{lh, In_xGa_{1-x}N} = m_{lh, GaN} + x(m_{lh, InN} - m_{lh, GaN}), \quad (11)
\]

where \(m_{e, In_xGa_{1-x}N}\) is the effective mass of electrons in \(In_xGa_{1-x}N\) material, \(m_{hh, In_xGa_{1-x}N}\) and \(m_{lh, In_xGa_{1-x}N}\) are the effective masses of heavy and light holes in \(In_xGa_{1-x}N\), respectively. \(m_{e, InN}\) for InN is 0.1\(m_0\) and \(m_{e, GaN}\) for GaN is 0.151\(m_0\), while \(m_{hh, InN}\) and \(m_{lh, InN}\) of InN are 1.44\(m_0\) and 0.157\(m_0\), respectively, and \(m_{hh, GaN}\) and \(m_{lh, GaN}\) are 1.595\(m_0\) and 0.261\(m_0\), respectively\(^{(10)}\), whereby \(m_0\) is the electron mass in the free space.

A schematic diagram of the LD structure is shown in Fig. 1. A 3-\(\mu m\) n-type GaN layer is assumed to be grown firstly, then followed by a 0.4-\(\mu m\) n-type \(Al_{0.07}Ga_{0.93}N\) cladding layer and a 0.1-\(\mu m\) n-type GaN guiding layer. The active region of the preliminary LD structure under study consists of a 3-\(nm\) \(In_{0.15}Ga_{0.87}N\) well that is sandwiched between two 6-\(nm\) GaN barriers. A 0.02-\(\mu m\) \(p-Al_{0.15}Ga_{0.85}N\) stop layer is assumed to be grown on the top of the active region, followed by a 0.1-\(\mu m\) p-type GaN guiding layer, a 0.4-\(\mu m\) \(p-Al_{0.07}Ga_{0.93}N\) cladding layer, and a 0.1-\(\mu m\) p-GaN contact layer.

For our InGaN/GaN LD, the parameters including the output power, threshold current, slope efficiency, and external DQE as functions of the well number are shown in Fig. 2. A maximum output power of 16.6 mW and a lowest threshold current of 13.1 mA are obtained when the quantum well number is two. These results are in line with other experimental results obtained by many researchers\(^{(6,12)}\). For fewer quantum wells, the gain begins to be saturated before lasing is achieved. For more quantum wells, increasing the current is needed to pump the additional wells above transparency.

In addition, laser structures with many quantum wells also suffer from inhomogeneity of the carrier density within the quantum wells, as shown in Fig. 3. It is seen that as the number of quantum wells increases, the nonuniformity of carrier injection increases too. It is also observed that the carrier distributions are inhomogeneous and increasing towards the p-side in the laser structure. This is ascribed to the poor hole injection due to the low mobility and thermal velocity of the hole itself. Thus, the hole density becomes higher on the p-side and the electrons are attracted to the p-side.

Fig. 1. Schematic diagram of the preliminary InGaN LD.

Fig. 2. Laser output power, slope efficiency, threshold current, and DQE as functions of well number of the MQWs InGaN LD. Cavity length \(L = 800 \mu m\), width \(W = 1 \mu m\), temperature \(T = 300 K\).

Fig. 3. Carrier density distribution profile in the InGaN MQWs LD.
The optical material gain inside the quantum wells is shown in Fig. 4. The quantum well in the left side (p-side) has a higher optical material gain due to the use of Al$_{0.15}$Ga$_{0.85}$N blocking layer in the p-side of which the electrons tend to accumulate in the left quantum well. The holes are difficult to be moved from the left quantum well to the right quantum well due to the relatively large effective mass, low mobility, and high band offset in the valence band. Therefore, more holes are expected in the left quantum well. Since the left quantum well possesses more electrons and holes as compared with the right quantum well, it has higher population inversion and hence higher stimulated recombination rate.

It was also found that the optical gain is generated in the two wells on the p-side. No gain value was observed in the third well in the n-side and this layer acted as an absorption layer that increased the laser threshold current and suppressed the quantum efficiency. As a result, it decreased the laser output power. The internal field in InGaN quantum wells causes the separation of the electron and hole wave functions, thus reducing the wave function overlap integral.

Consequently, when the carrier lifetime increases, the oscillator strength reduces. As the carrier density in the quantum well increases, screening of the internal field occurs. Hence, a blue shift of the laser emission wavelength was observed in our LD, as shown in Fig. 5[13]. The presence of the built-in electric field modifies the electronic states in quantum wells and lowers the optical gain of the active region of the laser. The electrons and holes are, indeed, spatially separated by the polarization field, but the free carrier induced field is opposite to the polarization field. The two fields tend to cancel each other out for higher sheet densities, thus re-establishing the conditions for the electron-hole recombination emission. The wavelength of the light emitted from LD quantum well depends not only on the bandgap, but also on the large internal electric field due to the PZ and spontaneous polarization. The PZ field arises from the strain due to the lattice mismatch between the InGaN well and the GaN barriers and causes the red shift in the optical transition energy.

Figure 6 shows the calculation method for the parameters of $\eta_i$ and $\alpha_i$ with respect to the inverse value of DQE as a function to the cavity length. We obtained the values of 97% and 9.69 cm$^{-1}$ of $\eta_i$ and $\alpha_i$ respectively in the case of double-quantum-well (DQW) LD. The values of internal quantum efficiency $\eta_i$ and internal loss $\alpha_i$ are a direct indication of the efficiency of our DQW InGaN LD. It can be seen that the value of the external DQE is smaller than the internal quantum efficiency, and this difference is related to the different internal loss mechanism in the LD device.

The transparency current $J_0$ is defined by the position of the quantum levels, the band structure parameters of the quantum level, and the band structure parameters of the strained material in the active region. In order to obtain $J_0$ value, we have plotted the curve of threshold current density versus the inverse cavity length, as shown in Fig. 7. The intercept of the linear fit line of the data plotted in this curve with the vertical axis provides us with the transparency threshold current density value. Then it is observed that the DQW has lower $J_0$ value compared with that in single-quantum-well (SQW) and triple-quantum-well (TQW), as shown in Fig. 8.

However, it is inexpedient to reduce the transparency current component by making the quantum well thinner
because of the strong decrease in the optical confinement factor and the rise in the threshold current density. Our results suggested reducing this parameter by changing the laser quantum well number instead of changing the quantum well thickness. The LD applications require good thermal stability of the employed LDs in terms of wavelength emission and threshold current. The thermal sensitivity of the latter parameter is described by an exponential equation as

\[ J_{th} = J_0 \exp\left(\frac{T}{T_0}\right), \]  

where \( T_0 \) is the characteristic temperature that jointly represents the temperature dependence of various mechanisms such as optical gain, radiative and non-radiative recombinations, carrier escape, etc., which determine the value of the device threshold current. However, the increase in the threshold current of the LD with device temperature is ascribed to that more current is needed to achieve the necessary population inversion at higher temperature, while the center wavelength of a LD is directly proportional to its operating temperature. Figure 9 shows that as the temperature increases, the threshold current increases and the DQE decreases due to the increases in the internal losses and non-radiative recombinations in the laser active region. Additionally, a red shift was observed in the laser peak emission wavelength with the increase in temperature.

Regarding the characteristic temperature \( T_0 \) of the LD, it is commonly referred to be a measure of the temperature sensitivity of the device. Higher values of \( T_0 \) imply that the threshold current density increases and the external DQE of the device decreases less rapidly with the increasing temperature. This is translated into the laser being more thermally stable. The characteristic temperature \( T_0 \) is determined by plotting the threshold current density \( J_{th} \) versus the laser device temperature on a logarithmic scale and then measuring the slope of the linear fit line, as shown in Fig. 10.

The inverse of the slope of the linear fit to this set of data points is the characteristic temperature \( T_0 \) value. InGaN TQW lasers showed strong temperature dependence of \( J_{th} \) as shown in Fig. 10 in the range of 280 – 340 K with the cavity length \( L \) of 800 \( \mu \)m. Our work implies that with the MQW structure, \( T_0 \) value of InGaN lasers could be greatly improved. We observed that InGaN SQW and TQW exhibit stronger temperature dependence than that of InGaN DQW lasers. This temperature dependence is determined by non-radiative recombination, current overflow, and other thermally activated processes. Additionally, the inhomogeneous carrier distribution observed in the quantum wells, is another important parameter that determines the reduction in the DQE value with the increase in temperature. We believe that there is still a large field for further optimization of the thermal stability in nitride devices since the highest reported \( T_0 \) is around 235 K\[[14]\].

In conclusion, we have found that the problem of inhomogeneous carrier distribution in InGaN LD structures deteriorates with the increase of quantum well number for the spectral range under study. The inhomogeneous carrier distributions in the quantum wells play an important role in the laser performance. The lowest threshold current, higher external quantum efficiency and characteristic temperature are obtained when the number of InGaN well layers is two at our laser emission wavelength of 415 nm. The effects of device temperature on the laser threshold current, external DQE, and output wavelength exhibit significant variation in these parameter values.

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